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Practitioner's Docket No. MI22-1208

PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Li et al., Weimin

Application No.: 09/388,826

Group No.: 2813

Filed: 09/01/99

Examiner: E.J. Kielin

For: Low k Interlevel Dielectric Layer Fabrication Methods

Assistant Commissioner for Patents  
Washington, D.C. 20231

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Response to May 1, 2002 Office Action

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6/14/02  
Harrison

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 09/388,826  
Filing Date ..... September 1, 1999  
Inventor ..... Weimin Li et al.  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2813  
Examiner ..... E.J. Kielin  
Attorney's Docket No. .... MI22-1208  
Title: Low k Interlevel Dielectric Layer Fabrication Methods

**RESPONSE TO MAY 1, 2002 OFFICE ACTION**

To: Box Non-Fee Amendment  
Assistant Commissioner for Patents  
Washington, D.C. 20231

From: Frederick M. Fliegel, Ph.D.  
Tel. 509-624-4276; Fax 509-838-3424  
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Sir:

Responsive to the Office Action dated May 1, 2002, Applicant remarks  
as follows: